Note: xxxFN (JEDEC SOP) is not available in

Japan.

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74LCX257F,TC74LCX257FN,TC74LCX257FT,TC74LCX257FK

Low-Voltage Quad 2-Channel Multiplexer (3-state) with 5-V Tolerant Inputs and Outputs

The TC74LCX257 is a high-performance CMOS multiplexer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for inputs.

It is composed of four independent 2-channel multiplexers with common select and  $\ \overline{OE}$  .

If  $\overline{OE}$  is set low, the outputs are held in a high-impedance state. When SELECT is set low, "A" data inputs are enabled. Conversely, when SELECT is high, "B" data inputs are enabled.

All inputs are equipped with protection circuits against static discharge.

#### **Features**

- Low-voltage operation: VCC = 2.0 to 3.6 V
- High-speed operation:  $t_{pd} = 6.0 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: -500 mA
- Available in JEDEC SOP, JEITA SOP, TSSOP and VSSOP(US)
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 257 type

SOP16-P-300-1.27A
TC74LCX257FN

SOL16-P-150-1.27
TC74LCX257FT

TSSOP16-P-0044-0.65A

Weight

TC74LCX257FK

 SOP16-P-300-1.27A
 : 0.18 g (typ.)

 SOL16-P-150-1.27
 : 0.13 g (typ.)

 TSSOP16-P-0044-0.65A
 : 0.06 g (typ.)

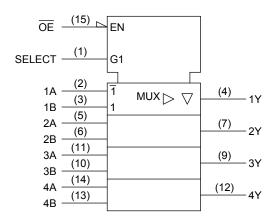
 VSSOP16-P-0030-0.50
 : 0.02 g (typ.)

VSSOP16-P-0030-0.50

# Pin Assignment (top view)

#### SELECT 16 $V_{\text{CC}}$ ŌĒ 15 1A 2 4A 1B 3 1Y 4B 4Y 2A 5 12 2B 6 3A 2Y 7 3B GND 3Y 8

# **IEC Logic Symbol**



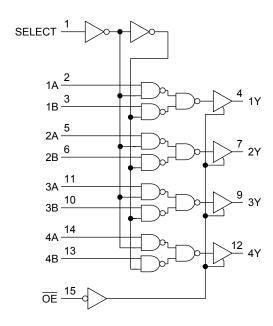
### **Truth Table**

	Outputs			
ŌĒ	SELECT	Α	В	Υ
Н	Х	X	X	Z
L	L	L	Х	L
L	L	Н	X	Н
L	Н	Х	L	L
L	Н	Х	Н	Н

X: Don't care

Z: High impedance

### **System Diagram**





### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	l <sub>IK</sub>	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND$ ,  $V_{OUT} > V_{CC}$ 

### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	2.0 to 3.6	V	
rower supply voltage	vCC	1.5 to 3.6 (Note 2)	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	Vour	0 to 5.5 (Note 3)	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub> (Note 4)		
Output current	I <sub>OH</sub> /I <sub>OI</sub>	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	ША	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



### **Electrical Characteristics**

### DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics		Symbol	Test Condition			Min	Max	Unit
		Symbol			V <sub>CC</sub> (V)	IVIIII	IVIAX	Unit
Input voltage	H-level	V <sub>IH</sub>	-	_	2.7 to 3.6	2.0	_	V
iliput voltage	L-level	V <sub>IL</sub>	-	_	2.7 to 3.6	_	0.8	v
				I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> -0.2	_	
	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_	
				$I_{OH} = -18 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2	_	V
			V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.7 to 3.6	_	0.2	
	L-level	V/		I <sub>OL</sub> = 12 mA	2.7	_	0.4	
L-ievei	L-level	V <sub>OL</sub>		I <sub>OL</sub> = 16 mA	3.0	_	0.4	
			I	I <sub>OL</sub> = 24 mA	3.0	_	0.55	
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		2.7 to 3.6	_	±5.0	μА
3-state output OFF state current		I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		2.7 to 3.6	_	±5.0	μА
Power-off leakage current		l <sub>OFF</sub>	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	10.0	μА
Quiescent supply current		Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7 to 3.6	_	10.0	
			V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		2.7 to 3.6	_	±10.0	μА
Increase in Icc per input		Δl <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		2.7 to 3.6	_	500	

## AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	_	6.5	ns
(A, B-Y)	t <sub>pHL</sub>	Tigate 1, Figure 2	$3.3 \pm 0.3$	1.5	6.0	110
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	_	8.5	ns
(SELECT-Y)	t <sub>pHL</sub>	r igure 1, r igure 2	$3.3 \pm 0.3$	1.5	7.0	115
Output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	2.7	_	8.5	ns
Output enable time	t <sub>pZH</sub>	ir igure 1, r igure 3	$3.3 \pm 0.3$	1.5	7.0	] 115
Output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	2.7	_	6.0	ns
t <sub>pHZ</sub>		i igure 1, i igure 3	$3.3 \pm 0.3$	1.5	5.5	113
Output to output skew	t <sub>osLH</sub>	(Note)	2.7	_	_	ns
Output to output skew	t <sub>osHL</sub>	(Note)	$3.3 \pm 0.3$	_	1.0	115

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, \, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 



### Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	8.0	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V

### **Capacitive Characteristics (Ta = 25°C)**

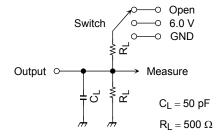
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	$f_{IN} = 10 \text{ MHz}$ (Not	3.3	25	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

### **AC Test Circuit**



Parameter	Switch
t <sub>pLH</sub> , t <sub>pHL</sub>	Open
$t_{pLZ}$ , $t_{pZL}$	6.0 V
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND

Figure 1

### **AC Waveform**

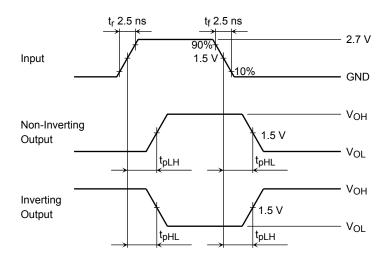


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

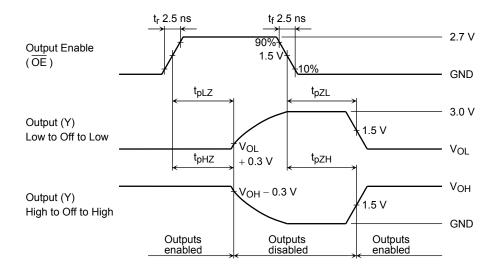
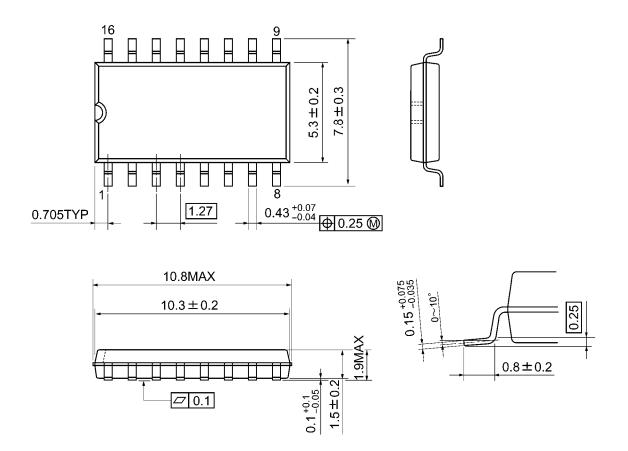


Figure 3  $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$ 

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# **Package Dimensions**

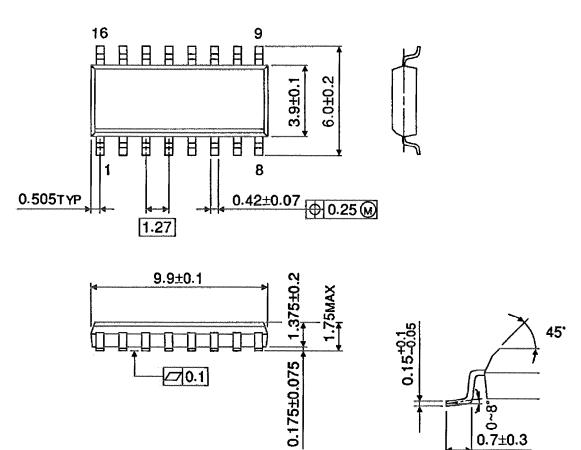
SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

# **Package Dimensions (Note)**

SOL16-P-150-1.27 Unit: mm



8

Note: This package is not available in Japan.

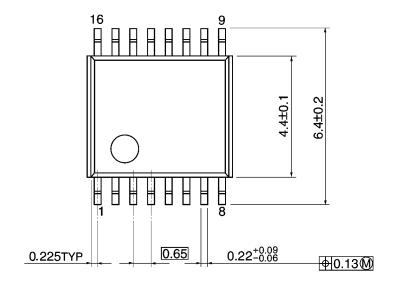
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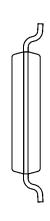
# **Package Dimensions**

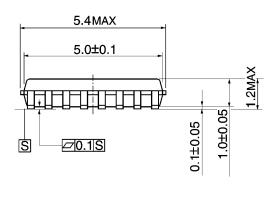
**TOSHIBA** 

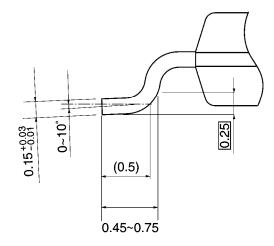
TSSOP16-P-0044-0.65A

Unit: mm







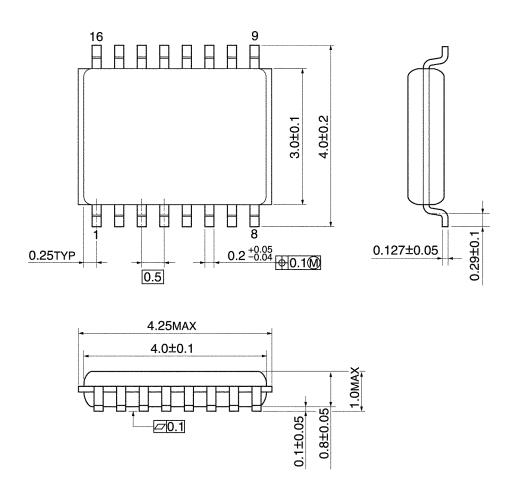


Weight: 0.06 g (typ.)

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# **Package Dimensions**

VSSOP16-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

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